

Features

- T1 3/4 cylindrical package.
- High luminous power.
- Typical chromaticity coordinates x=0.40, y=0.39 according to CIE1931.
- Available on tape and reel.
- ESD-withstand voltage: up to 4KV.
- The product itself will remain within RoHS compliant version



Descriptions

- The series is designed for application required high luminous intensity.
- The phosphor filled in the reflector converts the blue emission of InGaN chip to warm white.

Applications

- Message panels
- Optical Indicators
- Backlighting
- Marker Lights

Device Selection Guide

LED Part No.	Chip Material	Emitted Color	Lens Color
424/X1C9-1GKA	InGaN	Warm White	Water Clear

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Device Number DLE-0000708

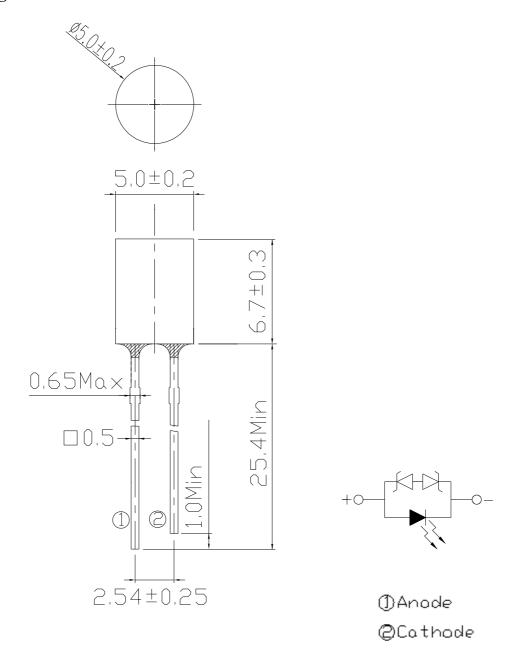
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Package Dimensions



Notes:

- 1.All dimensions are in millimeters, and tolerance is 0.25mm except being specified.
- 2.Lead spacing is measured where the lead emerges from the package.
- 3. Protruded resin under flange is 1.5mm Max. LED.

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Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	$ m I_F$	30	mA
Peak Forward Current(Duty /10 @ 1KHZ)	$ m I_{FP}$	100	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}$
Storage Temperature	T_{stg}	-40 ~ +100	$^{\circ}$
Soldering Temperature (T=5 sec)	T_{sol}	260	$^{\circ}$
Power Dissipation	P_d	110	mW
Zener Reverse Current	Iz	100	mA
Electrostatic Discharge	ESD	4K	V

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Production Designation

424/X1C9- [
_		
		Voltage Group
		Luminous Intensity Bins
		Color Group

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Forward Voltage	V_{F}	I _F =20mA	2.8		3.6	V
Zener Reverse Voltage	Vz	Iz=5mA	5.2			V
Reverse Current	I_R	V _R =5V			50	uA
Luminous Intensity	I_{V}	I _F =20mA	565		1425	mcd
Viewing Angle	201/2	I _F =20mA		100		deg
Chromotiaity Coordinates	X	I 20 A		0.40		
Chromaticity Coordinates	у	I _F =20mA		0.39		

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Luminous Intensity Combination (mcd at 20mA)

Rank	Min	Max
G	565	715
Н	715	900
J	900	1125
K	1125	1425

^{*}Measurement Uncertainty of Luminous Intensity: ±10%

Forward Voltage Combination (V at 20mA)

Rank	0	1	2	3
Forward Voltage	2.8~3.0	3.0~3.2	3.2~3.4	3.4~3.6

^{*}Measurement Uncertainty of Forward Voltage: ±0.1V

Color Combination (at 20mA)

Group	Bins	
1	D1+D2+E1+E2+F1+F2	

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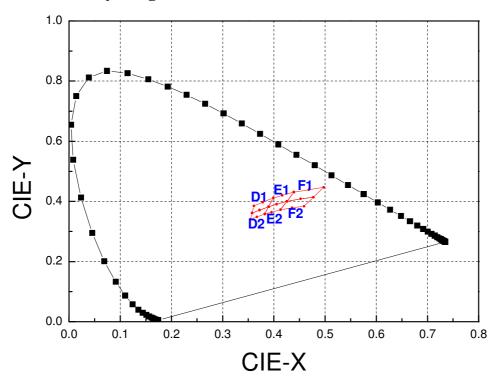
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CIE Chromaticity Diagram



Color Ranks (IF=20mA , $Ta=25^{\circ}C$)

Color Ran	ks		C	IE .	
DI	X	0.357	0.361	0.398	0.389
D1	Y	0.361	0.385	0.411	0.382
D2	X	0.354	0.357	0.389	0.382
D2	Y	0.340	0.361	0.382	0.358
F1	X	0.389	0.398	0.439	0.425
E1	Y	0.382	0.411	0.431	0.400
F2	X	0.382	0.389	0.425	0.412
E2	Y	0.358	0.382	0.400	0.372
E1	X	0.425	0.439	0.497	0.477
F1	Y	0.400	0.431	0.466	0.413
F2	X	0.412	0.425	0.477	0.458
F2	Y	0.372	0.400	0.413	0.383

*Measurement uncertainty of the color coordinates: ±0.01

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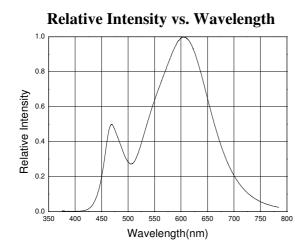
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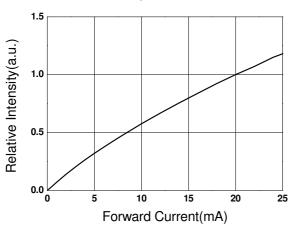
Technical Data Sheet

424/X1C9-1GKA

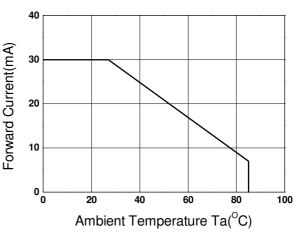
Typical Electro-Optical Characteristics Curves



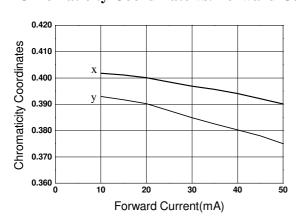
Relative Intensity vs. Forward Current



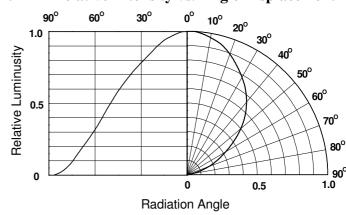
Forward Current vs. Ambient Temp.



Chromaticity Coordinate vs. Forward Current



Relative Intensity vs. Angle Displacement



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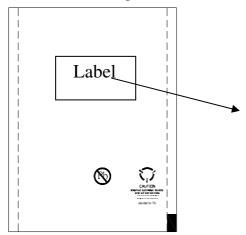


Technical Data Sheet

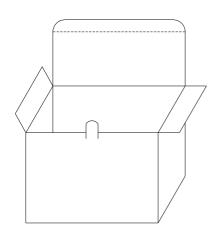
424/X1C9-1GKA

Packing Specification

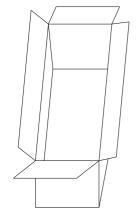
■ Anti-electrostatic bag



Inner Carton



Outside Carton





■ Label Form Specification

CPN: Customer's Production Number

P/N: Production Number QTY: Packing Quantity

CAT: Ranks of Luminous Intensity and Forward Voltage

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HUE: Color Rank REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

Packing Quantity

1. 500 PCS/1 Bag, 5 Bags/1 Inner Carton

2. 10 Inner Cartons/1 Outside Carton



Notes

1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

2. Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

3. Soldering

■ Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.

■ Recommended soldering conditions:

Hand Soldering		DIP Soldering		
Temp. at tip of iron	300°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max	
Distance	3mm Min.(From solder joint to epoxy bulb)	Distance	3mm Min. (From solder joint to epoxy bulb)	

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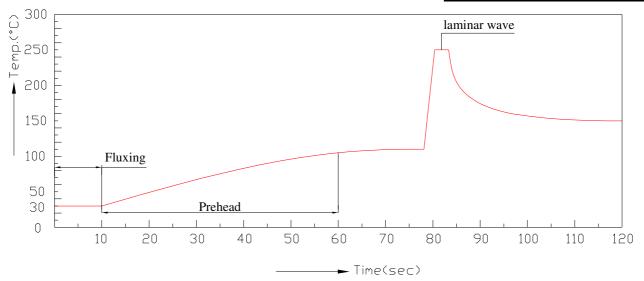
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- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

4. Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED

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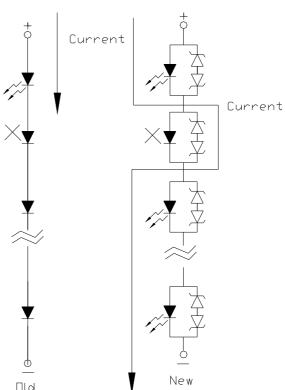
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5. Circuit Protection

- Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light up.



6. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

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7. ESD (Electrostatic Discharge)

- Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
- An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
- All devices, equipment and machinery must be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.

8. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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